032204

PATENT APPLICATION

15439 U.S. PTO 10/805890

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P.O. Box 1450
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Sir:

Enclosed herewith for filing under the provisions of 37 C.F.R. \$1.53(b) is the following continuation application of the prior, co-pending application United States Patent Application Serial No. 10/092,795, filed March 6, 2002 by Nallan, et al., which is herein incorporated into the present continuation application by reference in its entirety.

Applicant(s): Padmapani C. Nallan

Guangxiang Jin Ajay Kumar

Title of application: METHOD OF PLASMA ETCHING OF HIGH-K

DIELECTRIC MATERIALS WITH HIGH SELECTIVITY TO UNDERLYLING LAYERS

Pages of specification: 12 (3 pages of claims and 1 page

abstract)

Sheets of drawing: 4

Executed on: Docket No.: 7017 C1/ETCH/METAL-NVM/JB1

	PATENT APPLICA	TION FII		FEE CALCULA /Claim	TION Fee
Total Claims	20	-20	0	x \$18.00	\$ 0.00
Independent Claims	4	- 3	1	x \$86.00	\$ 86.00
	Minimu	ım Filin	g Fee		\$770.00
Multiple Dependency Fee (if applicable - \$280.0					\$

50% Reduction for Small Entity (Independent Inventor, Non-profit Corporation, or Small Business Concern) - appropriate verified statement attached

- \$ 0.00

Assignment Recordation Fee

\$ 40.00

TOTAL FILING FEE

\$896.00

Kindly charge the entire and any additional filing fee, as appropriate, to Deposit Account No. 20-0782. To facilitate that charge, a duplicate copy of this letter is enclosed herewith.

Kindly direct all correspondence to:

Patent Counsel Applied Materials, Inc. 3050 Bowers Avenue P.O. Box 450A Santa Clara, CA 95052

Also enclosed herewith for filing in connection with the enclosed application are:

- X A copy of the executed Declaration of the prior application 10/092,795 from the co-inventors to Applied Materials, Inc., which remains in effect for the subject continuation application
- X Claim(s) to priority under 35 U.S.C. §120:

 Serial Number Filing date

 10/092,795 March 6, 2002
- X The above-identified prior application (10/092,795) is co-pending.
- X The Assignment of the prior application 10/092,795 from the co-inventors to Applied Materials, Inc., which remains in effect for the subject continuation application
- X 4 sheets of formal drawings.

Respectfully submitted,

Mar 22, 2004

KEITH TABOADA, Attorney

Reg. No. 45,150

EXPRESS MAIL CERTIFICATION

"Express Mail" mailing label number: __EV367690141US

Date of deposit: <u>March 22, 2004</u>
I hereby certify that this patent application and related papers is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-14150.
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Allyson M. DeVesty Name of person mailing paper or fee